DATA SHEET



Solid State Relay OCMOS FET PS7801M-1A

4-PIN ULTRA SMALL FLAT-LEAD, LOW C × R (3.4 pF • Ω)

1-ch Optical Coupled MOS FET

-NEPOC Series-

DESCRIPTION

The PS7801M-1A is a low output capacitance solid state relay containing a GaAs LED on the light emitting side (input side) and MOS FETs on the output side.

An ultra small flat-lead package has been provided which realizes a reduction in mounting area of about 50% compared with the PS72xx series.

It is suitable for high-frequency signal control, due to its low $C \times R$ (3.4 pF • Ω), low output capacitance, and low off-state leakage current.

FEATURES

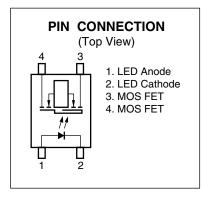
- Ultra small flat-lead package (4.2 (L) \times 2.5 (W) \times 1.85 (H) mm)
- Low $C \times R$ ($C \times R = 3.4 \text{ pF} \cdot \Omega$)
- Low output capacitance (Cout = 0.95 pF TYP.)
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Low offset voltage
- Ordering number of taping product: PS7801M-1A-F3: 3 500 pcs/reel
- Pb-Free product
- · Safety standards

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• UL approved: No. E72422

APPLICATIONS

Measurement equipment

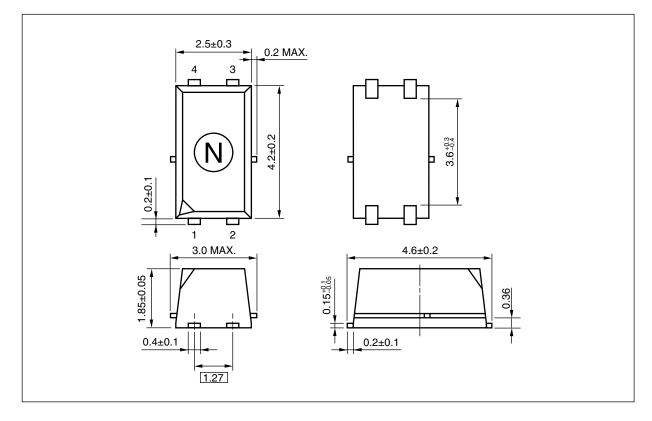


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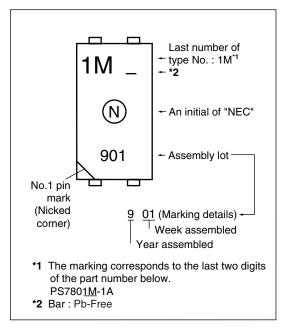
The mark <R> shows major revised points. © NEC Electronics Corporation 2007, 2009

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Packing Style		Safety Standard Approval	Application Part Number ^{*1}
PS7801M-1A	PS7801M-1A-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS7801M-1A
PS7801M-1A-F3	PS7801M-1A-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	PD	50	mW
	Peak Forward Current ^{*1}	I FP	1	А
MOS FET	Break Down Voltage	VL	20	V
	Continuous Load Current	IL.	160	mA
	Pulse Load Current ^{*2} (AC/DC Connection)	Ilp	240	mA
	Power Dissipation	PD	250	mW
Isolation Voltage ³		BV	500	Vr.m.s.
Total Power Dissipation		Ρτ	300	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 μ s, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

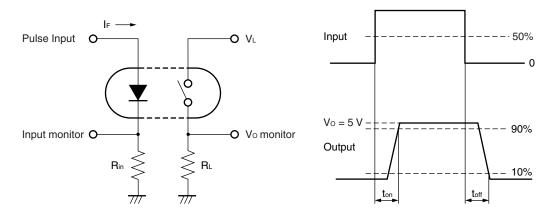
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	4.5	5	20	mA
LED Off Current	IF	0.1			mA

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 5 mA		1.1	1.4	V
	Reverse Current	IR	V _R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V _D = 20 V		0.03	0.25	nA
	Output Capacitance	Cout	$V_D = 0 V$, f = 1 MHz, t \leq 1 s		0.95	1.5	pF
Coupled	LED On-state Current	IFon	l∟ = 160 mA			4	mA
	On-state Resistance	Ron	I_{F} = 5 mA, I_{L} = 160 mA, t \leq 10 ms		3.6	5.0	Ω
	Turn-on Time ^{*1, 2}	ton	I⊧ = 5 mA, V₀ = 5 V, R∟ = 500 Ω,		0.05	0.25	ms
	Turn-off Time ^{*1, 2}	toff	PW ≥ 0.5 ms		0.03	0.25	
	Isolation Resistance	Ri-o	VI-O = 0.5 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		0.3		pF

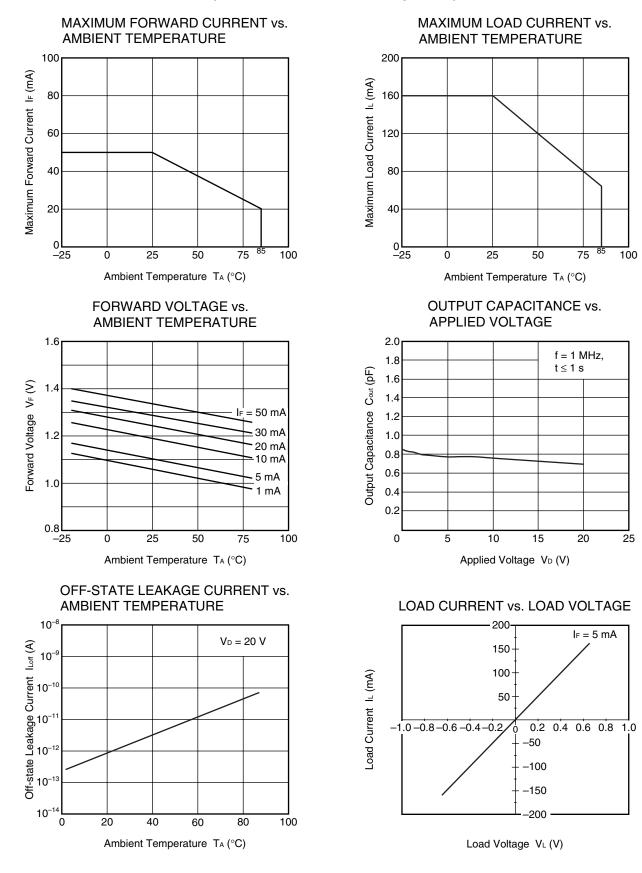
ELECTRICAL CHARACTERISTICS (TA = 25°C)

*1 Test Circuit for Switching Time



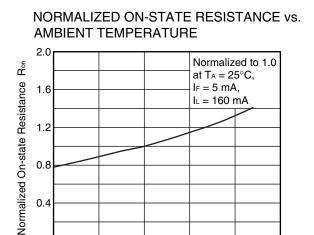
*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 0.5 ms.
 Be aware that when the device operates with an input-pulse width less than 0.5 ms, the turn-on time and turn-off time will increase.

<R> TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

0∟ -25



Ambient Temperature TA (°C)

50

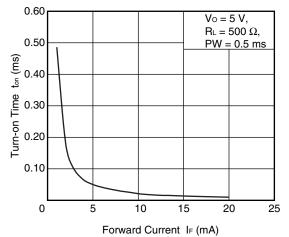
75

100

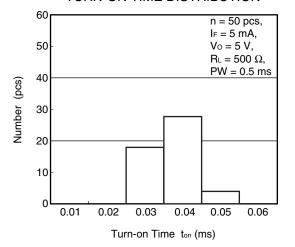
25

0



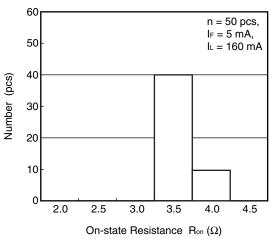


TURN-ON TIME DISTRIBUTION

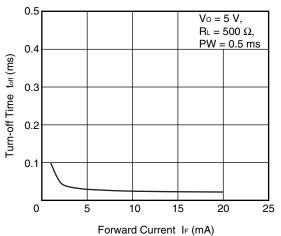




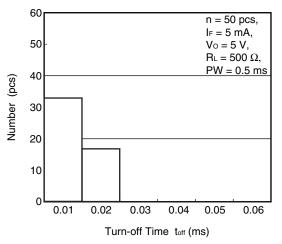
ON-STATE RESISTANCE DISTRIBUTION

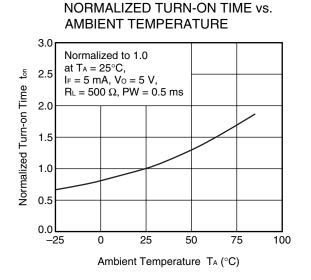


TURN-OFF TIME vs. FORWARD CURRENT

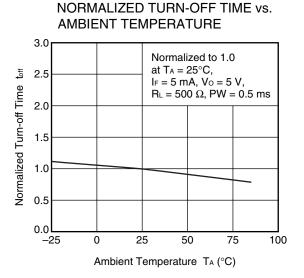


TURN-OFF TIME DISTRIBUTION

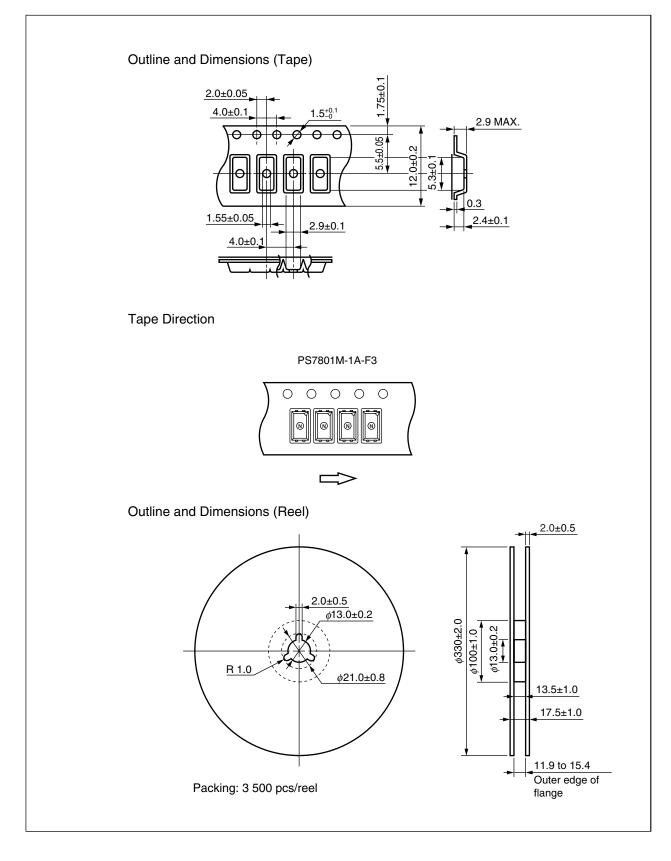




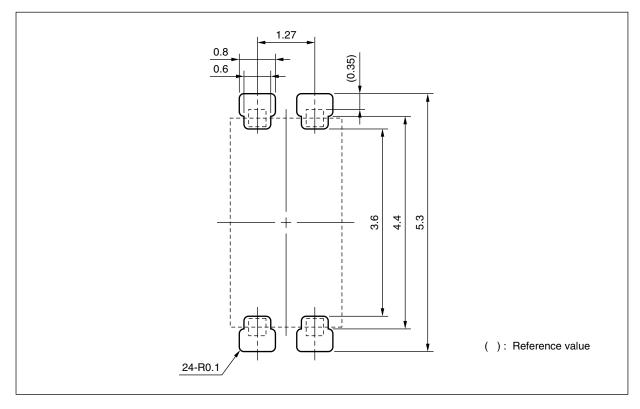
Remark The graphs indicate nominal characteristics.



TAPING SPECIFICATIONS (UNIT: mm)







Remark All dimensions in this figure must be evaluated before use.

RECOMMENDED SOLDERING CONDITIONS

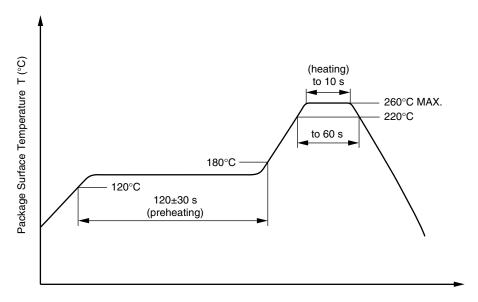
(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

- 260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s
- Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 	260°C or below (molten solder temperature)
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- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

350°C or below
3 seconds or less
Rosin flux containing small amount of chlorine (The flux with a
maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.